IEEE 802.3da SPMD TF meeting
September 8th, 2021

Prepared by Peter Jones

Presentations posted at:
https://www.ieee802.org/3/da/index.html

Agenda/Admin - Chad Jones

All times in Pacific Time (PT)

7:00am: The Chair reviewed the agenda. The Chair asked if there were any corrections or additions to the agenda.

7:02am There being no corrections or additions, the agenda stands approved.

The Chair advised that the minutes for 8/11 and 8/25 have not been posted yet.

7:06am: Call for patents (see below) was made, no one responded. From the "INSTRUCTIONS FOR THE WG CHAIR" slide:

- Instruct the WG Secretary to record in the minutes of the relevant WG meeting:
    - That the foregoing information was provided and that slides 1 through 4 (and this slide 0, if applicable) were shown;
    - That the chair or designee provided an opportunity for participants to identify patent claim(s)/patent application claim(s) and/or the holder of patent claim(s)/patent application claim(s) of which the participant is personally aware and that may be essential for the use of that standard
    - Any responses that were given, specifically the patent claim(s)/patent application claim(s) and/or the holder of the patent claim(s)/patent application claim(s) that were identified (if any) and by whom.

7:10am: Opening agenda slides complete. The meeting moves on to presentations.

Presentations/Discussion.

7:10am: 802.3da Clause 147 Multidrop Interoperability,
     Jason Potterf, Cisco

8:21am: presentation & Q&A done.

8:21am: Discussion of comment cycle, timeline, work items, etc
     Chad Jones, Cisco

8:28am: presentation & Q&A done.

Next meeting: 22 September, 7:00am PT.

Meeting closed –8:28am PT

Attendees (from Webex + emails)

Name	Employer	Affiliation	Attended 09/08
Anthony New	Prysmian Group	Prysmian Group	y
Bob Voss	Panduit Corp.	Panduit Corp.	y
Brian Murray	Analog Devices Inc.	Analog Devices Inc.	y
Chad Jones	Cisco Systems, Inc.	Cisco Systems, Inc.	y
Chris Diminico	MC Communications	Panduit	y
Christopher Pohl	Beckhoff Automation	Beckhoff Automation	y
Dave Hess	Cord Data	Cord Data	y
David D. Brandt	Rockwell Automation	Rockwell Automation	y
David Law	Hewlett Packard Enterprise	Hewlett Packard Enterprise	y
Denis Beaudoin	Texas Instruments	Texas Instruments	y
Fred Dawson	Chemours Canada Company	Chemours Canada Company	y
Geoff Thompson	GraCaSI S.A.	Independent	y
George Zimmerman	CME Consulting	ADI, APL Group, Cisco Systems, CommScope, Marvell, SenTekSe	y
Gergely Huszak	Self	Kone	y
Heath Stewart	Analog Devices Inc.	Analog Devices Inc.	y
Jason Potterf	Cisco Systems, Inc.	Cisco Systems, Inc.	y
Jerome BRENGUIER	Schneider Electric	Schneider Electric	y
Jodi Haasz	IEEE SA	IEEE SA	y
Joe Aronson	Texas Instruments	Texas Instruments	y
Kirsten Matheus	BMW Group	BMW Group	y
Kiyoshi Saito	Furukawa Electric	Furukawa Electric	y
Masato Shiino	Furukawa	Furukawa	y
Michael Paul	Analog Devices Inc.	Analog Devices Inc.	y
Paul Vanderlaan	UL LLC	UL LLC	y
Peter Fischer	BKS Kabel-Service AG	BKS Kabel-Service AG	y
Peter Jones	Cisco Systems, Inc.	Cisco Systems, Inc.	y
Peter Wu	Marvell	Marvell	y
Rick Frosch	Phihong USA Inc,	Phihong USA Inc,	y
Rory Buchanan	OnSemi	OnSemi	y
Sami Akin	Volkswagen AG	Volkswagen AG	y
Scott Wade	WadeLux Limited	DiiA	y
Sebastian Konewko	Rockwell Automation	Rockwell Automation	y
Simon Mark	Wurthe Elektronik	Wurthe Elektronik	y
Talal Alhammami	CARIAD	CARIAD	y
Thomas Mueller	Rosenberger	Rosenberger	y

Thorrsten Hoffleit	Renesas	Renesas	y
Tim Baggett	Microchip Technology, Inc.	Microchip Technology, Inc.	y
Tobias Islinger	Infineon Technologies AG	Infineon Technologies AG	y
Valerie Maguire	Siemon	Siemon	y
Victor Renteria	Bel Fuse	Bel Fuse	y
Walter Downey	Dialog Semiconductor	Dialog Semiconductor	y
Wensheng Sun	Marvell	Marvell	y
Woojung Huh	Microchip	Microchip	y
Yung-Le Chang	Realtek	Realtek	y
Attendees			44